



## SUSS EXPOSURE TECHNOLOGIES



#### **Proximity Exposure**

Lithographic Wafer & Substrate Structuring

Micro-bumping, Flip Chip, Wafer-Level-Packaging

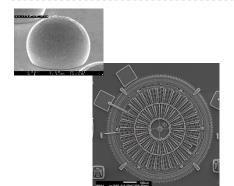
MEMS, RF, Power Devices, Photonics, LED

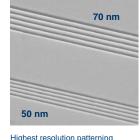
#### **Nano- and Micro-Imprinting**

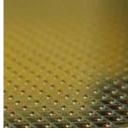
Nano- & Micro-Structuring

WLO, Photonics, ID recognition, AR (DOE,

optical gratings), medical, surface patterning







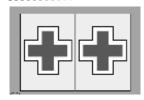
Highest resolution patterning

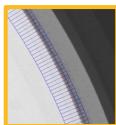
on glass substrate

#### Metrology

**Image Processing** 

**Smart Manufacturing Solutions** 

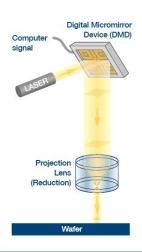




#### **Direct Write Projection**

Individual Die Processing Highly flexible patterning

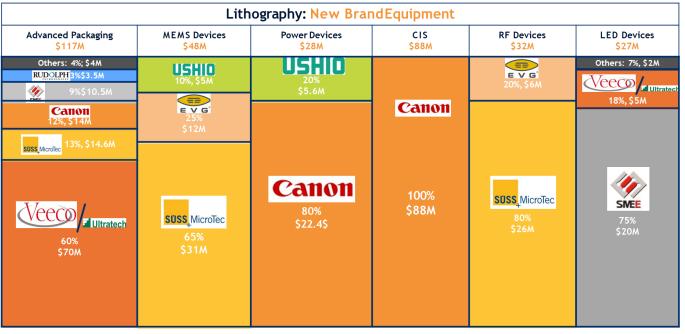


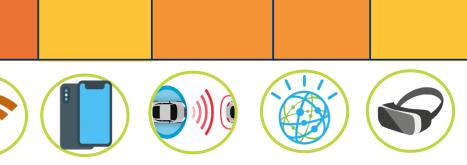


# MORE THAN MOORE MARKET AND TECHNOLOGY TRENDS - APPLICATION DRIVERS FOR SUSS EXPOSURE TECHNOLOGIES



- → Demand for "More than Moore" equipment is expected at CAGR of 7%-10% by Yole Développement
- + SUSS Exposure solutions have a dominant share for MEMS and RF devices
- + Target to expand share in Advanced Packaging with Direct Write Projection





**MEMS** 

New-brand Lithography equipment market (number of tools) Split by More than Moore device 300 250 Number of tools 200 150 100 **CAGR** ■ RF 57 7% ■ Power ■ CIS 12 12 10 12 LED 8% 10%

Source: Yole (2018, 2019)

RF

#### TARGET APPLICATIONS FOR MICRO-IMPRINT

**SUSS** MicroTec

confidentia

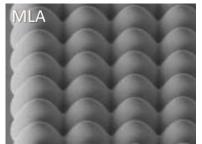


**UV - stacking** 











**Light carpets** 

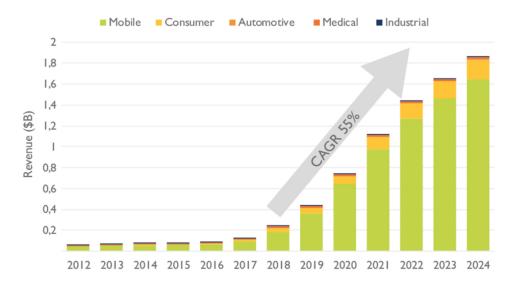
**Camera modules** 

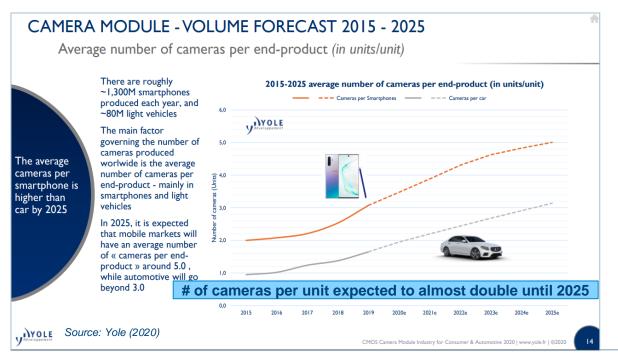
**Fingerprint sensors** 

Face ID optics
Time of Flight sensors

# 2012-2024 Wafer Level Optics revenue forecast by application (in \$B)

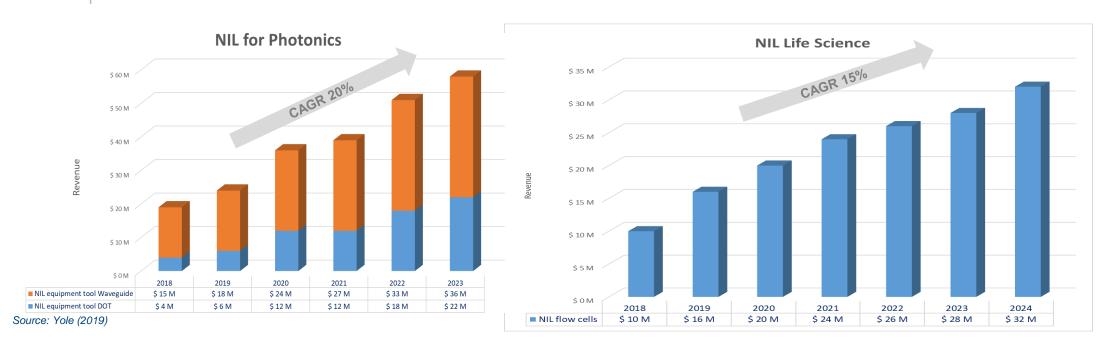
(Source: Status of the Camera Module Industry 2019 - Focus on wafer level optics , Yole Développement, February 2019)





#### TARGET APPLICATIONS FOR NANO-IMPRINT





Nano - Imprint



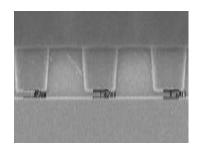
**Telecommunication**Optical nano-gratings



Virtual reality visors
Optical gratings



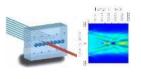
**Augmented Reality**Diffractive optical elements

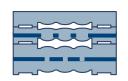


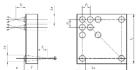
**Life science**DNA sequencing, organ-on-chip

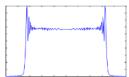
# **IMPRINT EXCELLENCE CENTER FULL SERVICE @ SUSS MICROOPTICS SITE**











Optical Design, System Design, **Micro-Optics Simulation** 













Fully equipped metrology lab for inspection and sorting of micro-optical components. (ISO 9001, IATF 16949, Six Sigma)

















Full access to peripheral tooling (Master and stamp fabrication, etching, dicing)







From feasibility studies for micro- and nanoimprint up to small volume production Full production environment using the expertise of SUSS MicroOptics volume fabrication Start-Up service for SUSS customers

# Feedback Loop

# SUSS METROLOGY: ENABLER FOR PRODUCTION TOOLS

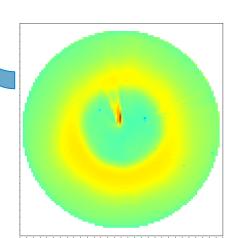


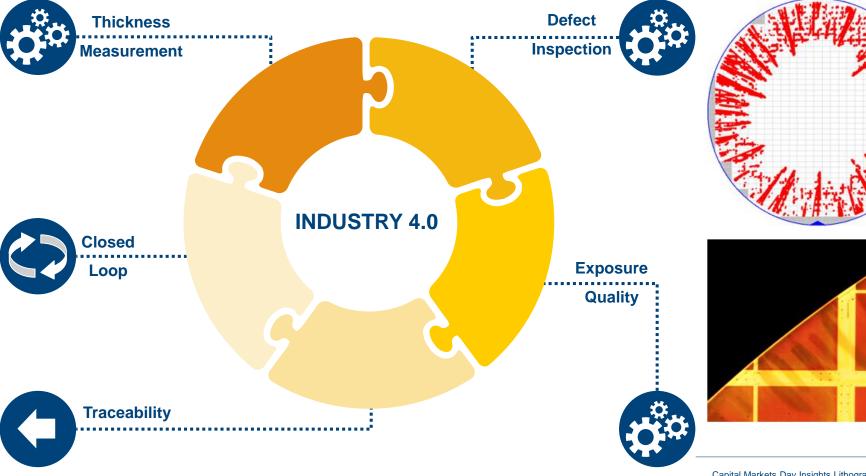
### Enhance product portfolio with Smart Manufacturing Solutions – Secure the High Wafer Value



#### **Automation:**

- **Adjust Recipe**
- Repeat process
- **Alert host**





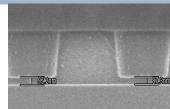
## PRODUCT PORTFOLIO



#### **SUSS Exposure Systems**



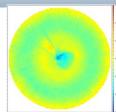












**Semi-Automated Aligners** 

**Automated Aligners** 

**Imprint** 

Metrology







MA12



MA150



MA200



MA300



XLC200 (coming soon)



DSM200



DI200

Comment / **USP** 

Large install base, very versatile

Only offer in the market. Used for special Morethan-Moore

Very high throughput, Linear transport, For cost-sensitive applications

Flagship product. Large install base, very versatile Overlay < 1um

Only offer in market. Used for Advanced Packaging with less challenging requirements

Development targeted for HVM applications in both markets, micro-imprint and nano-imprint. Strong process focus together with SMO

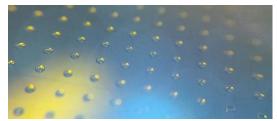
DSM is dedicated offering for back-side alignment processes. Modules integrated in SUSS systems for smart manufacturing control

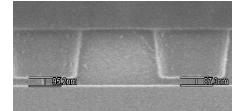
# SUMMARY GROWTH POTENTIAL – ON TRACK WITH SUSS STRATEGY 2025 PROJECTION





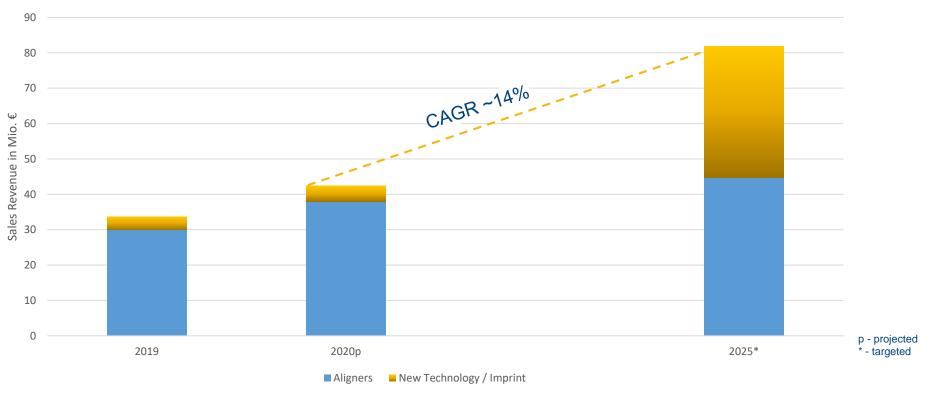








#### Forecast Sales Revenue Exposure €M - most likely scenario





Thank you.